



SVC276 — Diffused Junction Type Silicon Diode

FM Receiver Electronic Tuning Applications

Features

- Twin type with a good linearity of C-V characteristic. Excels in large input characteristic
- Small package permits SVC276-applied sets to be compact and slim
- High capacitance ratio ($V_R=2.0$ to $8.0V$)
- High Quality Factor

Specifications

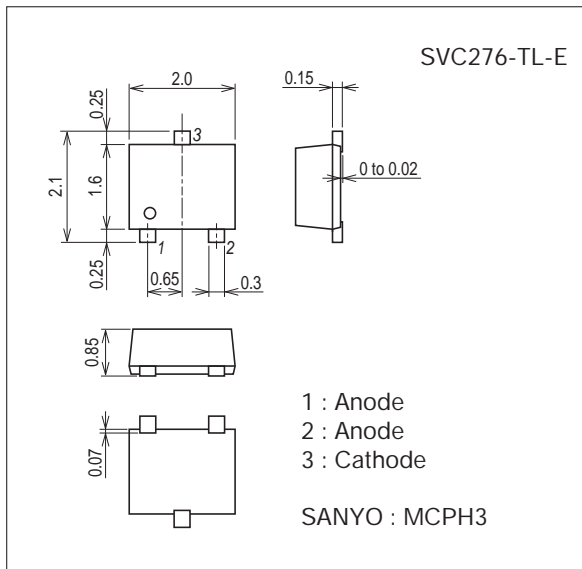
Absolute Maximum Ratings at $T_a=25^\circ C$

Parameter	Symbol	Conditions	Ratings	Unit
Reverse Voltage	V_R		16	V
Junction Temperature	T_j		125	$^\circ C$
Storage Temperature	T_{stg}		-55 to +125	$^\circ C$

Package Dimensions

unit : mm (typ)

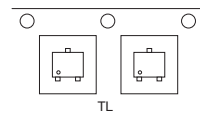
7019A-002



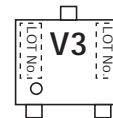
Product & Package Information

- Package : MCPH3
- JEITA, JEDEC : SC-70, SOT-323
- Minimum Packing Quantity : 3,000 pcs./reel

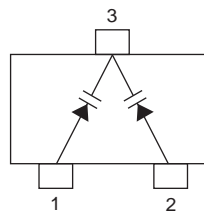
Packing Type : TL



Marking



Electrical Connection



SVC276

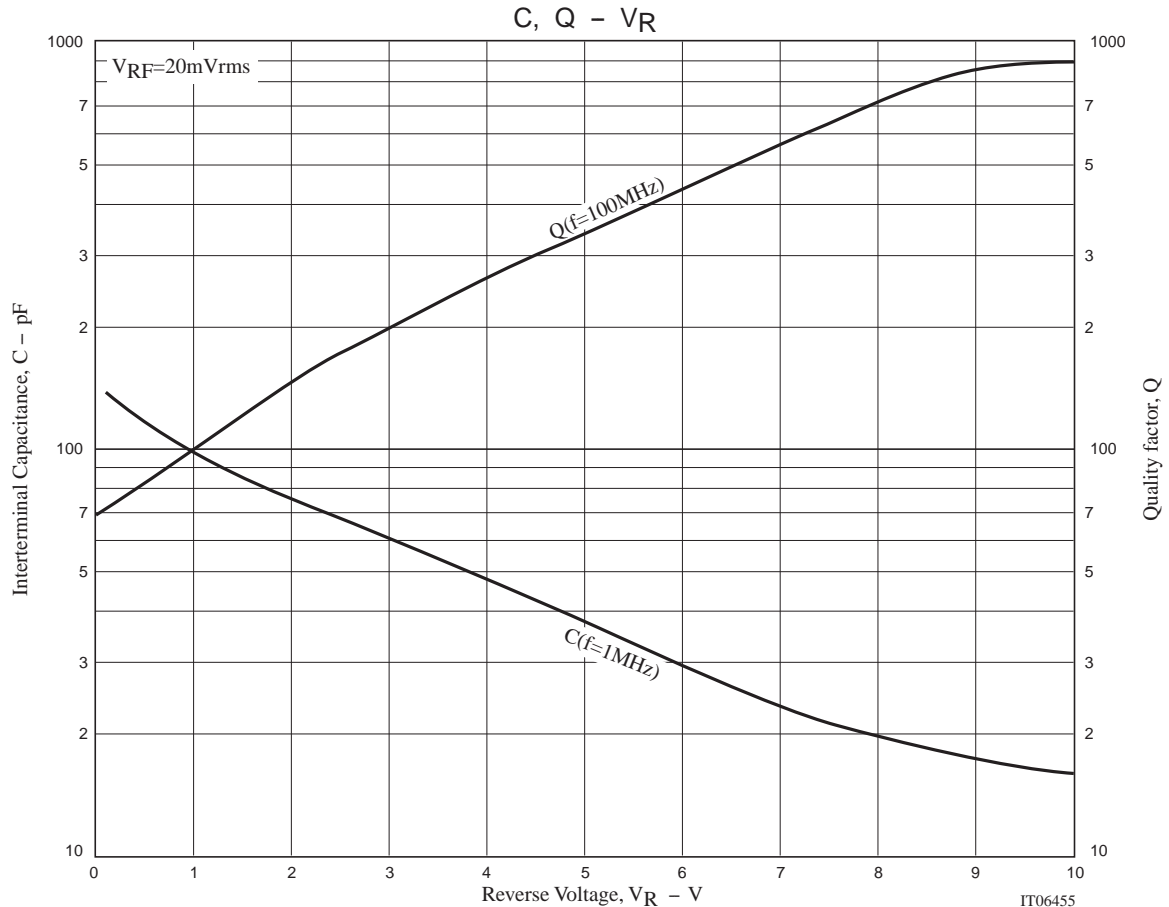
Electrical Characteristics at Ta=25°C

Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	
Breakdown Voltage	V(BR)R	I _R =10μA	16			V
Reverse Current	I _R	V _R =10V			50	nA
Interterminal Capacitance*	C2.0V	V _R =2.0V, f=1MHz	73.72		79.77	pF
	C6.0V	V _R =6.0V, f=1MHz	25.50		33.61	pF
	C8.0V	V _R =8.0V, f=1MHz	18.04		23.78	pF
Quality Factor	Q	V _R =2.0V, f=100MHz	100			
Capacitance Ratio	C _R	C2.0V / C8.0V	3.1			

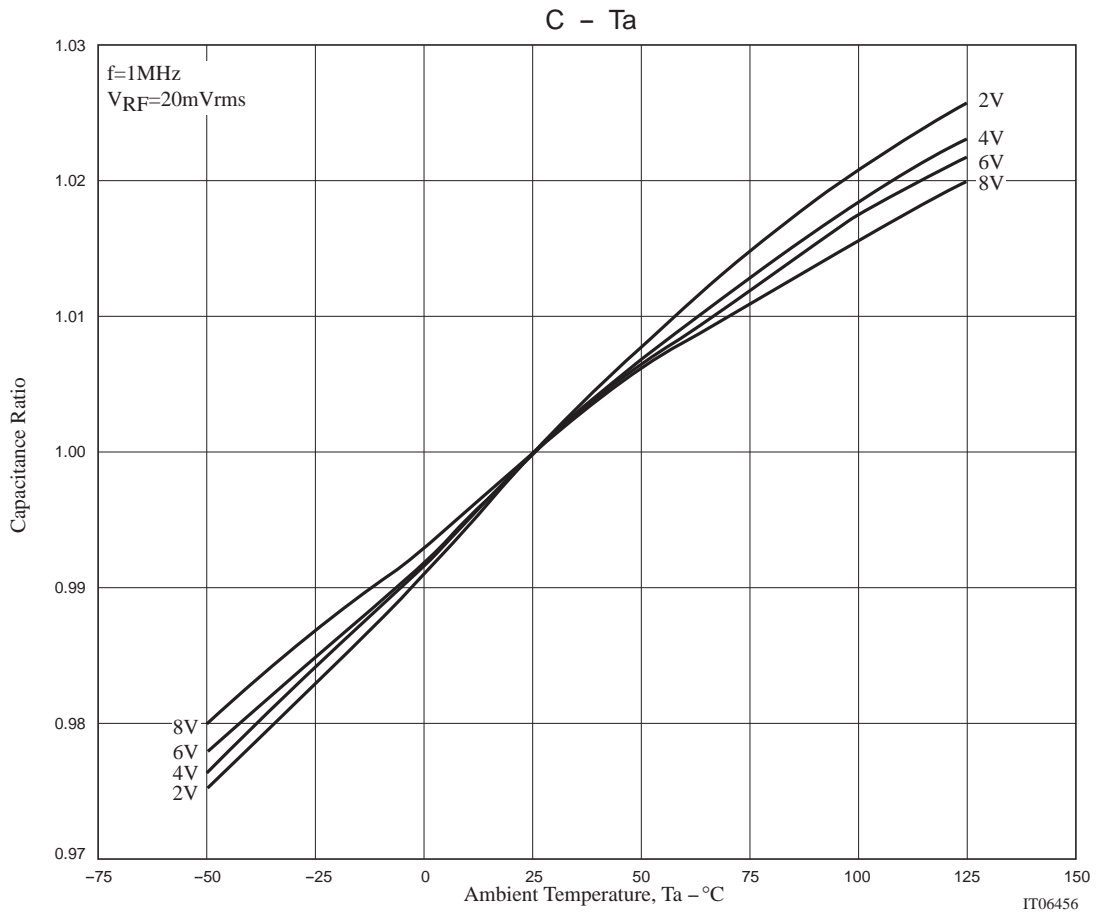
Note)* : Capacitance value per each diode

Ordering Information

Device	Package	Shipping	memo
SVC276-TL-E	MCPH3	3,000pcs./reel	Pb Free



SVC276



Taping Specification

SVC276-TL-E

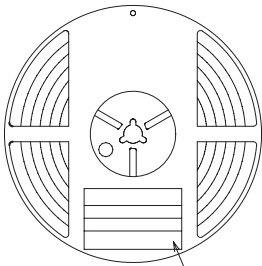
1. Packing Format

Package Name	Carrier Tape Type	Maximum Number of devices contained (pcs)			Packing format	
		Reel	Inner box	Outer box	Inner BOX (C-1)	Outer BOX (A-7)
MCPH3	MCPH3	3,000	15,000	90,000	5 reels contained Dimensions:mm (external) 183×72×185	6 inner boxes contained Dimensions:mm (external) 440×195×210

Reel label, Inner box label
(unit: mm)

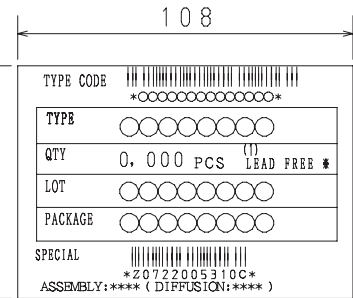
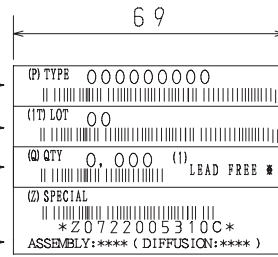
Outer box label
It is a label at the time of factory shipments.
The form of a label may change in physical distribution process.

Packing method



Type No.
LOT No.
Quantity
Origin

Reel label



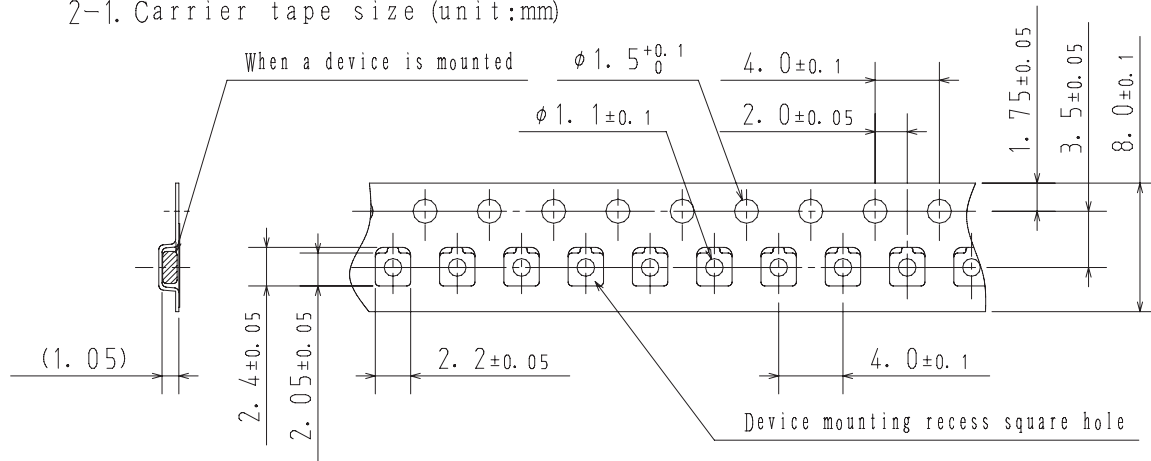
NOTE (1)

The LEAD FREE * description shows that the surface treatment of the terminal is lead free.

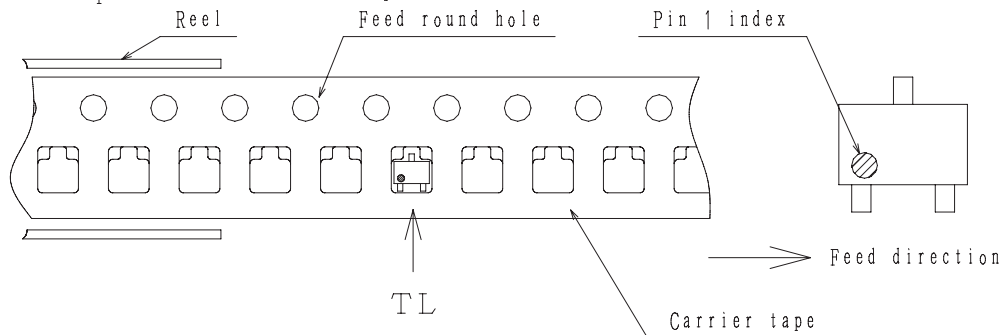
Label	JEITA Phase
LEAD FREE 3	JEITA Phase 3A
LEAD FREE 4	JEITA Phase 3

2. Taping configuration

2-1. Carrier tape size (unit:mm)



2-2. Device placement direction



Those with pin 1 index on the feed hole side.....TL

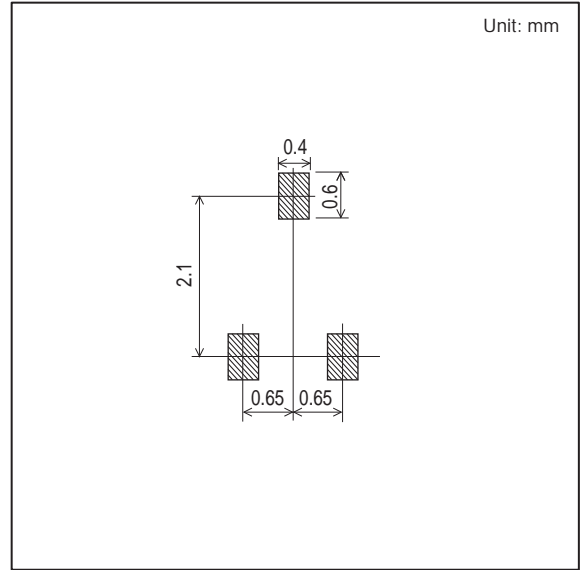
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Outline Drawing

SVC276-TL-E



Land Pattern Example



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